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Attorney Docket No. 108298515US  
Disclosure No. 99-1352

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Scott E. Moore  
APPLICATION NO.: 09/651,779  
FILED: August 30, 2000  
FOR: **METHODS AND APPARATUS FOR  
REMOVING CONDUCTIVE MATERIAL  
FROM A MICROELECTRONIC SUBSTRATE**

EXAMINER: Dung V. Nguyen  
ART UNIT: 3723  
CONF. No: 2448

**Supplemental Information Disclosure Statement**  
**As Submission Under 37 C.F.R. § 1.114**

Box RCE  
Commissioner for Patents  
Washington, D.C. 20231

**RECEIVED**  
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Sir:

TECHNOLOGY CENTER R3700

1. Timing of Submission

This information disclosure is being filed with a Request for Continued Examination under 37 C.F.R. § 1.114. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

2. Cited Information

☒ Copies of the following references are enclosed:

- ☒ All cited references
- ☐ References marked by asterisks
- ☐ The following:

☐ Copies of the following references can be found in parent U.S. Application No.:

- ☐ All cited references
- ☐ References marked by asterisks
- ☐ The following:

☒ The following references are not in English. For each such reference, the undersigned has enclosed (i) a translation of the reference; (ii) a copy of a communication from a foreign patent office or International Searching Authority citing the reference, (iii) a copy of a reference which appears to be an English-language counterpart, or (iv) an English-language abstract for the reference prepared by a third party. Applicant has not verified that the translation, English-language counterpart or third-party abstract is an accurate

representation of the teachings of the non-English reference, though, and reserves the right to demonstrate otherwise.

- ☐ All cited references
- ☐ References marked by a pound sign (#)
- ☒ The following: JP 2001077117 A1

3. Effect of Information Disclosure Statement.(37 CFR 1.97(h))

This Information Disclosure Statement is not to be construed as a representation that: (i) a search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the cited information is, or is considered to be, material to patentability. In addition, applicant does not admit that any enclosed item of information constitutes prior art to the subject invention and specifically reserves the right to demonstrate that any such reference is not prior art.

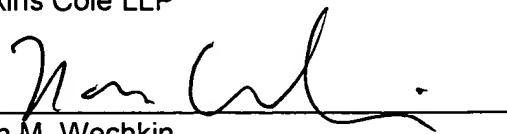
4. Fee Payment

No fees are believed due. However, should the Commissioner determine that fees are due in order for this Information Disclosure Statement to be considered, the Commissioner is hereby authorized to charge such fees to Deposit Account No. 50-0665.

5. Patent Term Adjustment (37 CFR 1.704(d))

- ☐ The undersigned states that each item of information submitted herewith was cited in a communication from a foreign patent office in a counterpart application and that this communication was not received by any individual designated in 37 C.F.R. § 1.56(c) more than thirty days prior to the filing of this statement. 37 C.F.R. § 1.704(d).

Respectfully submitted,  
Perkins Coie LLP

  
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Date: April 30, 2003

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